

Vishay Siliconix

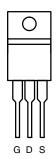
N-Channel 75 V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ)	
75	0.0048 at V _{GS} = 10 V	90 ^d	105	
75	0.006 at V _{GS} = 8 V	90 ^d	105	

FEATURES

- TrenchFET® Power MOSFET
- 175 °C Junction Temperature
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

TO-220AB

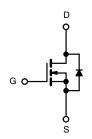


Top View

Ordering Information: SUP90N08-4m8P-E3 (Lead (Pb)-free)

APPLICATIONS

- Power Supply
 - Half-Bridge
 - Secondary Synchronous Rectification
- Industrial



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage	V _{DS}	75	V			
Gate-Source Voltage	V _{GS}	V _{GS} ± 20				
Continuous Drain Current (T _{.I} = 175 °C)	T _C = 25 °C	1-	90 ^d	A		
Continuous Diain Current (1) = 173 C)	T _C = 70 °C	I _D	90 ^d			
Pulsed Drain Current	I _{DM}	240	^			
Avalanche Current	I _{AS}	70				
Single Pulse Avalanche Energy ^a	L = 0.1 mH	E _{AS}	245	mJ		
	T _C = 25 °C	P _D	300 ^b	W		
Maximum Power Dissipation ^a	T _A = 25 °C ^c	' D	3.75			
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	40	- °C/W	
Junction-to-Case (Drain)	R _{thJC}	0.5		

Notes:

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.
- c. When mounted on 1" square PCB (FR-4 material).
- d. Package limited.

SUP90N08-4m8P

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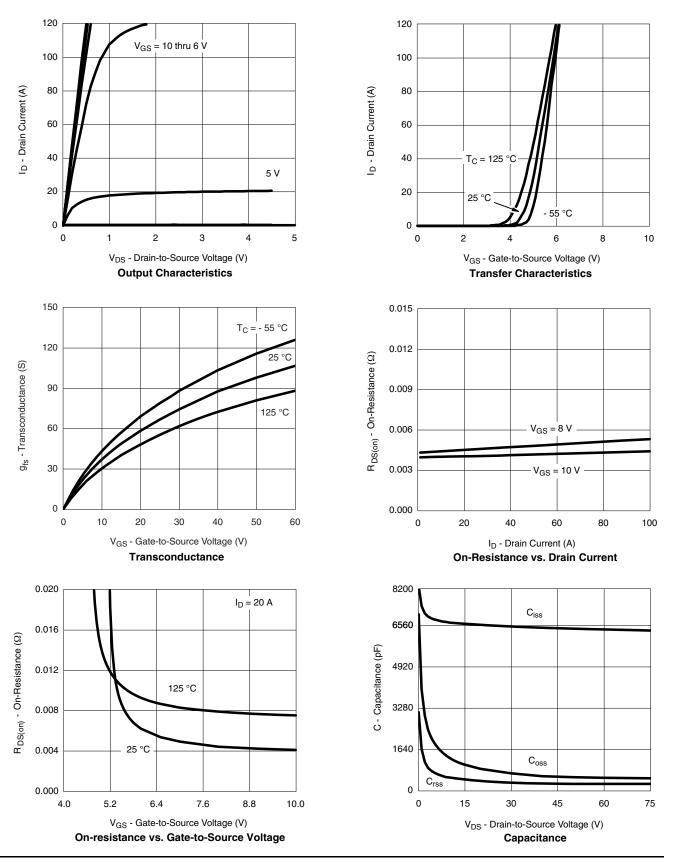
SPECIFICATIONS (T _C = 25	°C, unless	otherwise noted)				
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V_{DS}	$V_{DS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	75			- v
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2		4	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 250	nA
		$V_{DS} = 75 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 75 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$			50	
		V _{DS} = 75 V, V _{GS} = 0 V, T _J = 150 °C			250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	70			Α
		V _{GS} = 10 V, I _D = 20 A		0.004	0.0048	Ω
	D	V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C			0.0096	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 8 V, I _D = 20 A, T _J = 150 °C			0.0106	
		V _{GS} = 8 V, I _D = 20 A		0.0046	0.006	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		58		S
Dynamic ^b						
Input Capacitance	C _{iss}			6460		pF
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 40 \text{ V}, f = 1 \text{ MHz}$		571		
Reverse Transfer Capacitance	C _{rss}			275		
Total Gate Charge ^c	Qg			105	160	nC
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 85 \text{ A}$		32		
Gate-Drain Charge ^c	Q _{gd}			28		
Gate Resistance	R_{g}	f = 1 MHz		1.3	2.6	Ω
Turn-On Delay Time ^c	t _{d(on)}			23	35	
Rise Time ^c	t _r	V_{DD} = 30 V, R_L = 0.4 Ω I_D \cong 85 A, V_{GEN} = 10 V, R_g = 1 Ω		17	26	ns
Turn-Off Delay Time ^c	t _{d(off)}			34	52	
Fall Time ^c	t _f			8	15	
Source-Drain Diode Ratings and Cha	aracteristics (T _C = 25 °C) ^b				
Continuous Current	I _S				85	^
Pulsed Current	I _{SM}				240	Α
Forward Voltage ^a	V _{SD}	I _F = 30 A, V _{GS} = 0 V		0.85	1.5	V
Reverse Recovery Time	t _{rr}			68	100	ns
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 75 A, dI/dt = 100 A/μs		2.6	4	А
Reverse Recovery Charge	Q _{rr}			88	132	nC

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

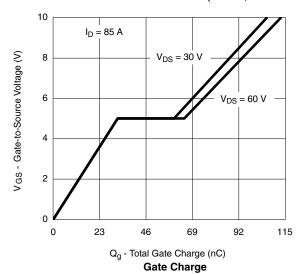


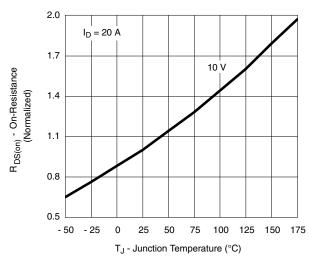
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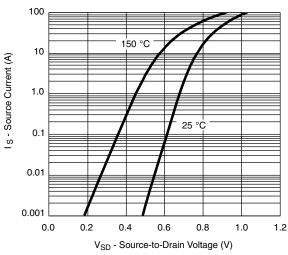


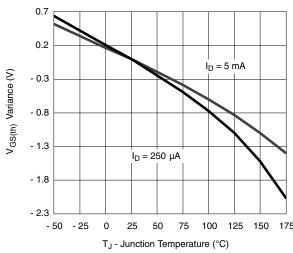
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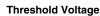


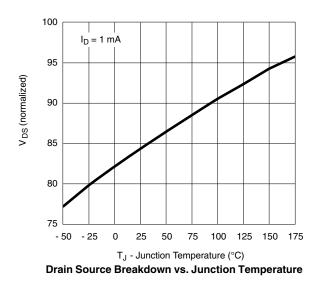
On-Resistance vs. Junction Temperature

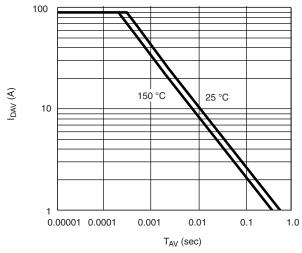




Source-Drain Diode Forward Voltage



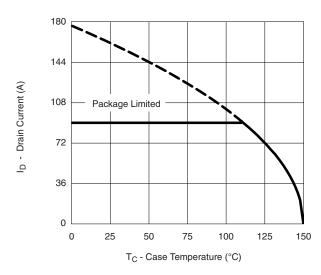


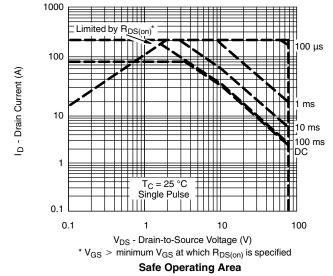


Single Pulse Avalanche Current Capability vs. Time

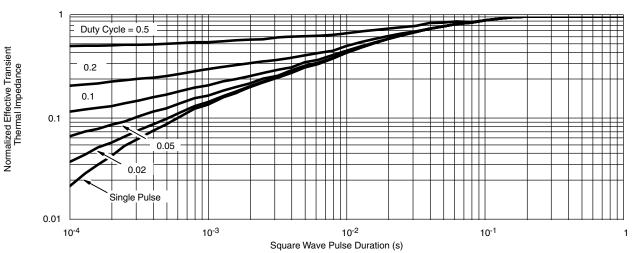
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Maximum Drain Current vs. Case Temperature



Normalized Thermal Transient Impedance, Junction-to-Case

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